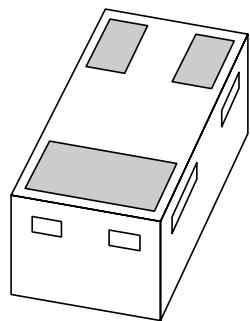


# DATA SHEET



**PBSS2515M**  
15 V, 0.5 A  
NPN low  $V_{CEsat}$  (BISS) transistor

Product specification  
Supersedes data of 2003 Jun 17

2003 Sep 15

**Philips**  
Semiconductors



**PHILIPS**

# 15 V, 0.5 A

## NPN low $V_{CEsat}$ (BISS) transistor

PBSS2515M

### FEATURES

- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability  $I_C$  and  $I_{CM}$
- High efficiency leading to reduced heat generation
- Reduced printed-circuit board requirements.

### APPLICATIONS

- Power management:
  - DC-DC converter
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- Peripheral driver:
  - Driver in low supply voltage applications (e.g. lamps and LEDs)
  - Inductive load drivers (e.g. relays, buzzers and motors).

### DESCRIPTION

Low  $V_{CEsat}$  NPN transistor in a SOT883 leadless ultra small plastic package.

PNP complement: PBSS3515M.

### MARKING

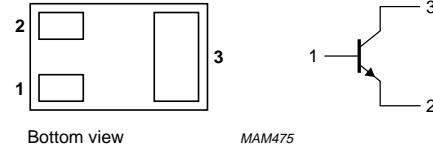
TYPE NUMBER	MARKING CODE
PBSS2515M	S2

### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	15	V
$I_C$	collector current (DC)	500	mA
$I_{CM}$	peak collector current	1	A
$R_{CEsat}$	equivalent on-resistance	<500	$\text{m}\Omega$

### PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



Bottom view

MAM475

Fig.1 Simplified outline (SOT883) and symbol.

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**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	15	V
$V_{CEO}$	collector-emitter voltage	open base	–	15	V
$V_{EBO}$	emitter-base voltage	open collector	–	6	V
$I_C$	collector current (DC)	notes 1 and 2	–	500	mA
$I_{CM}$	peak collector current		–	1	A
$I_{BM}$	peak base current		–	100	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$ ; notes 1 and 2	–	250	mW
		$T_{amb} \leq 25^\circ\text{C}$ ; note 1 and 3	–	430	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	junction temperature		–	150	°C
$T_{amb}$	operating ambient temperature		–65	+150	°C

**Notes**

1. Refer to SOT883 standard mounting conditions.
2. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60  $\mu\text{m}$  copper strip line.
3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1  $\text{cm}^2$ .

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	in free air; notes 1 and 2	500	K/W
		in free air; notes 1, 3 and 4	290	K/W

**Notes**

1. Refer to SOT883 standard mounting conditions.
2. Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60  $\mu\text{m}$  copper strip line.
3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1  $\text{cm}^2$ .
4. Operated under pulsed conditions: duty cycle  $\delta \leq 20\%$ , pulse width  $t_p \leq 30$  ms.

**Soldering**

Reflow soldering is the only recommended soldering method.

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**CHARACTERISTICS** $T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

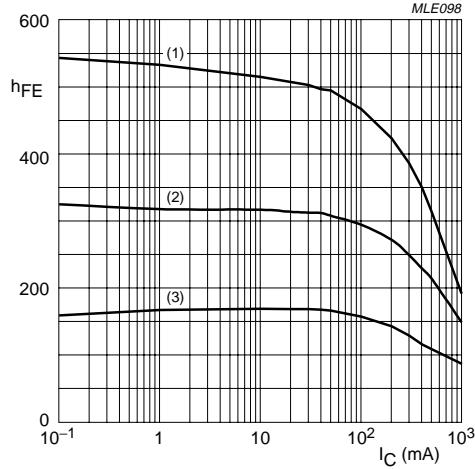
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 15\text{ V}; I_E = 0$	—	—	100	nA
		$V_{CB} = 15\text{ V}; I_E = 0; T_j = 150^\circ\text{C}$	—	—	50	$\mu\text{A}$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5\text{ V}; I_C = 0$	—	—	100	nA
$h_{FE}$	DC current gain	$V_{CE} = 2\text{ V}; I_C = 10\text{ mA}$	200	—	—	
		$V_{CE} = 2\text{ V}; I_C = 100\text{ mA}; \text{note 1}$	150	—	—	
		$V_{CE} = 2\text{ V}; I_C = 500\text{ mA}; \text{note 1}$	90	—	—	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 10\text{ mA}; I_B = 0.5\text{ mA}$	—	—	25	mV
		$I_C = 200\text{ mA}; I_B = 10\text{ mA}; \text{note 1}$	—	—	150	mV
		$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	—	250	mV
$R_{CEsat}$	equivalent on-resistance	$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	360	<500	$\text{m}\Omega$
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	—	1.1	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = 2\text{ V}; I_C = 100\text{ mA}; \text{note 1}$	—	—	0.9	V
$f_T$	transition frequency	$I_C = 100\text{ mA}; V_{CE} = 5\text{ V}; f = 100\text{ MHz}$	250	420	—	MHz
$C_c$	collector capacitance	$V_{CB} = 10\text{ V}; I_E = I_e = 0; f = 1\text{ MHz}$	—	4.4	6	pF

**Note**

1. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$ .

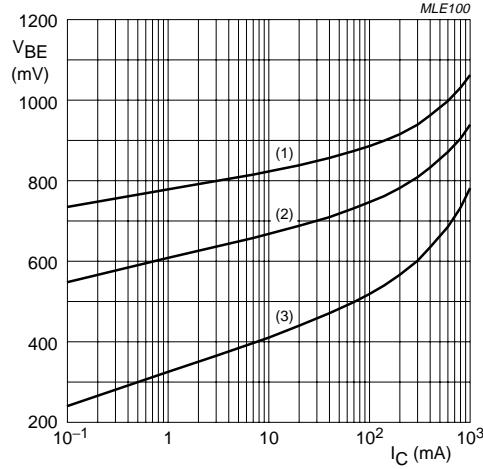
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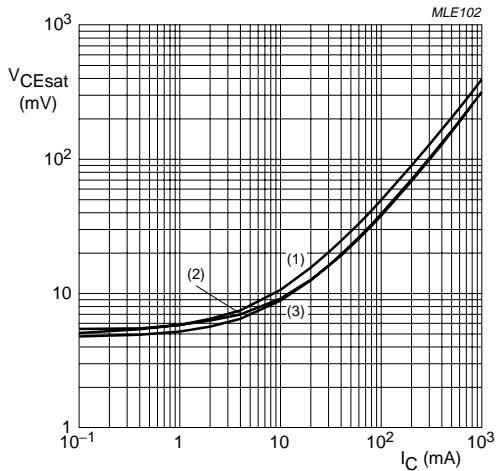
$V_{CE} = 2$  V.  
(1)  $T_{amb} = 150$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = -55$  °C.

Fig.2 DC current gain as a function of collector current; typical values.



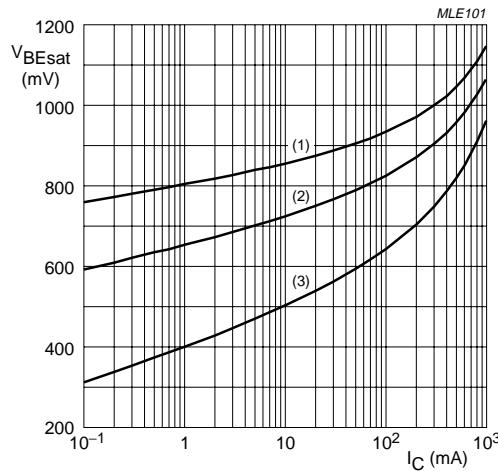
$V_{CE} = 2$  V.  
(1)  $T_{amb} = -55$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = 150$  °C.

Fig.3 Base-emitter voltage as a function of collector current; typical values.



$I_C/I_B = 20$ .  
(1)  $T_{amb} = 150$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = -55$  °C.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.

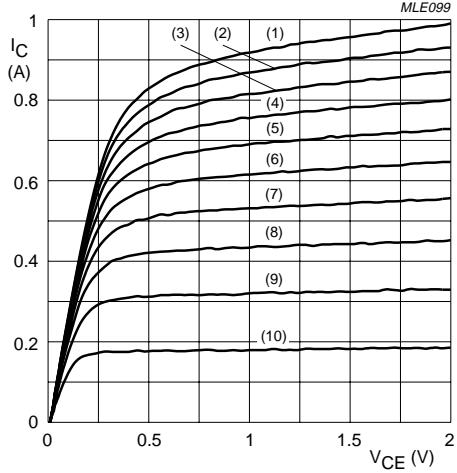


$I_C/I_B = 20$ .  
(1)  $T_{amb} = 150$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = -55$  °C.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

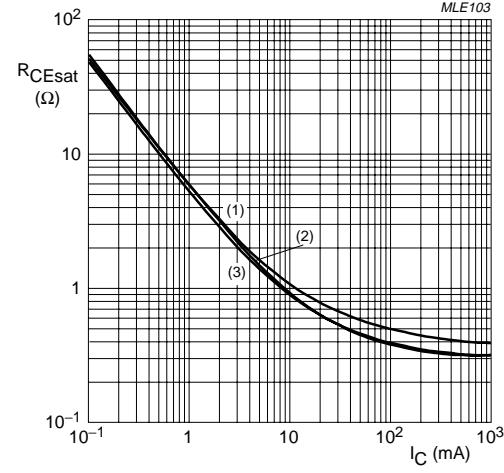
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 $T_{amb} = 25^\circ\text{C}$ .

(1) $I_B = 7 \text{ mA}$ .	(5) $I_B = 4.2 \text{ mA}$ .	(9) $I_B = 1.4 \text{ mA}$ .
(2) $I_B = 6.3 \text{ mA}$ .	(6) $I_B = 3.5 \text{ mA}$ .	(10) $I_B = 0.7 \text{ mA}$ .
(3) $I_B = 5.6 \text{ mA}$ .	(7) $I_B = 2.8 \text{ mA}$ .	
(4) $I_B = 4.9 \text{ mA}$ .	(8) $I_B = 2.1 \text{ mA}$ .	

Fig.6 Collector current as a function of collector-emitter voltage; typical values.

 $I_C/I_B = 20$ .

(1) $T_{amb} = 150^\circ\text{C}$ .
(2) $T_{amb} = 25^\circ\text{C}$ .
(3) $T_{amb} = -55^\circ\text{C}$ .

Fig.7 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

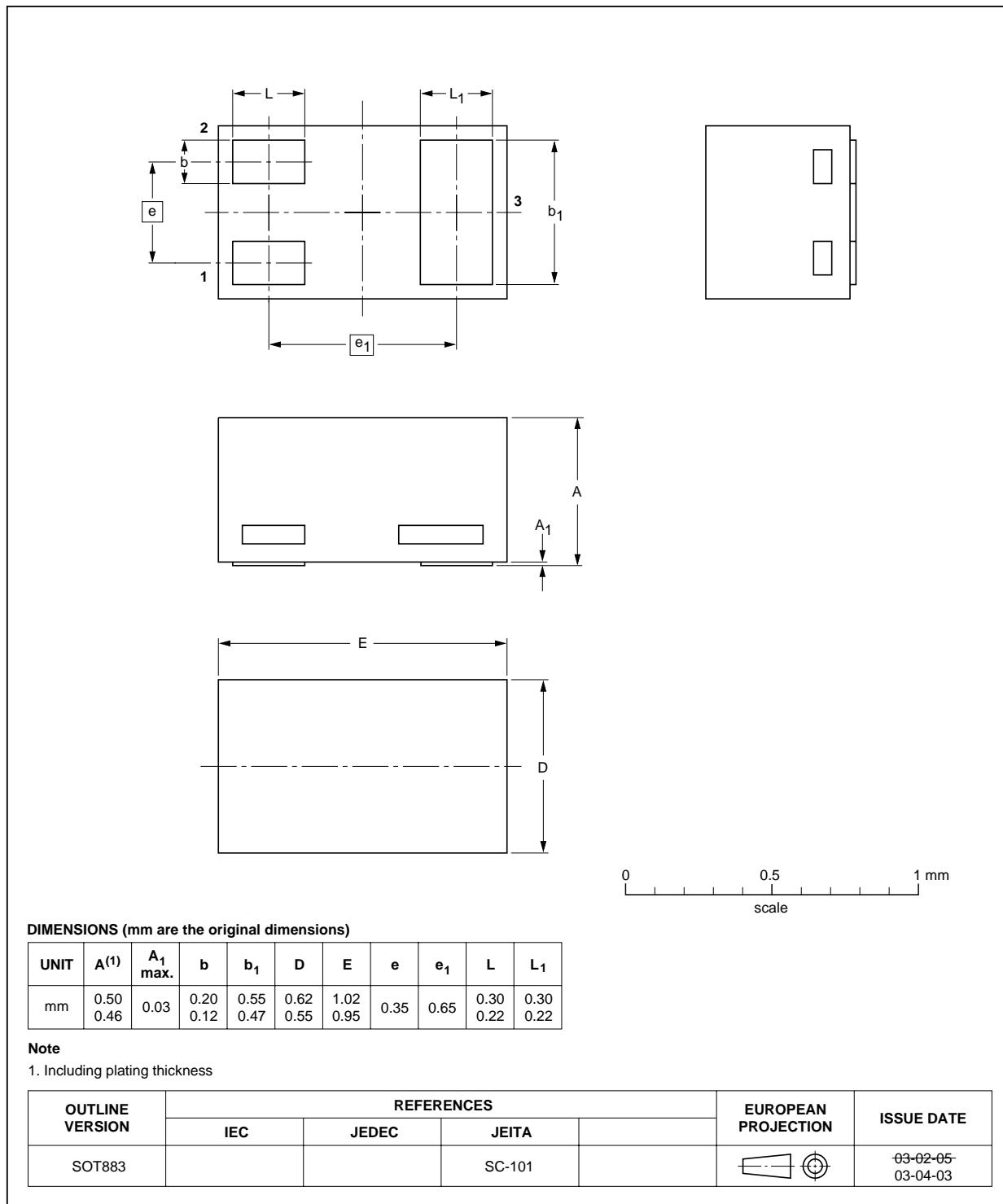
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## PACKAGE OUTLINE

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



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PBSS2515M

## DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
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